

SS26AFH

60 V, 2 A low leakage current Schottky barrier rectifier

2 August 2024 **Product data sheet**

1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD123FL small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Extremely low leakage current I_R = 235 nA
- Average forward current: $I_{F(AV)} \leq 2$ A
- Reverse voltage: $V_R \leq 60$ V
- Low forward voltage V_F = 600 mV
- High power capability due to clip-bonding technology
- High temperature $T_j \leq 175$ °C
- Small and flat lead SMD plastic package

3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- Low power consumption applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{sp} \leq$ 165 °C		-	-	2	A
V_R	reverse voltage	T_j = 25 °C		-	-	60	V
V_F	forward voltage	I_F = 2 A; $t_p \leq$ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	600	670	mV
I_R	reverse current	V_R = 60 V; $t_p \leq$ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	235	700	nA

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	 Transparent top view **SOD123FL**	 *sym001*
2	A	anode		

[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
SS26AFH	SOD123FL	plastic, surface mounted package; 2 terminals; 3 mm x 1.9 mm x 1 mm body	SOD123FL

7. Marking

Table 4. Marking codes

Type number	Marking code
SS26AFH	PN

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T_j = 25 °C		-	60	V
I_F	forward current	δ = 1; T_{sp} = 160 °C		-	2.83	A
$I_{F(AV)}$	average forward current	δ = 0.5; f = 20 kHz; square wave; T_{sp} ≤ 165 °C		-	2	A
I_{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	50	A
P_{tot}	total power dissipation	T_{amb} ≤ 25 °C	[1]	-	680	mW
			[2]	-	1.15	W
T_j	junction temperature			-	175	°C
T_{amb}	ambient temperature			-55	175	°C
T_{stg}	storage temperature			-65	175	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2.

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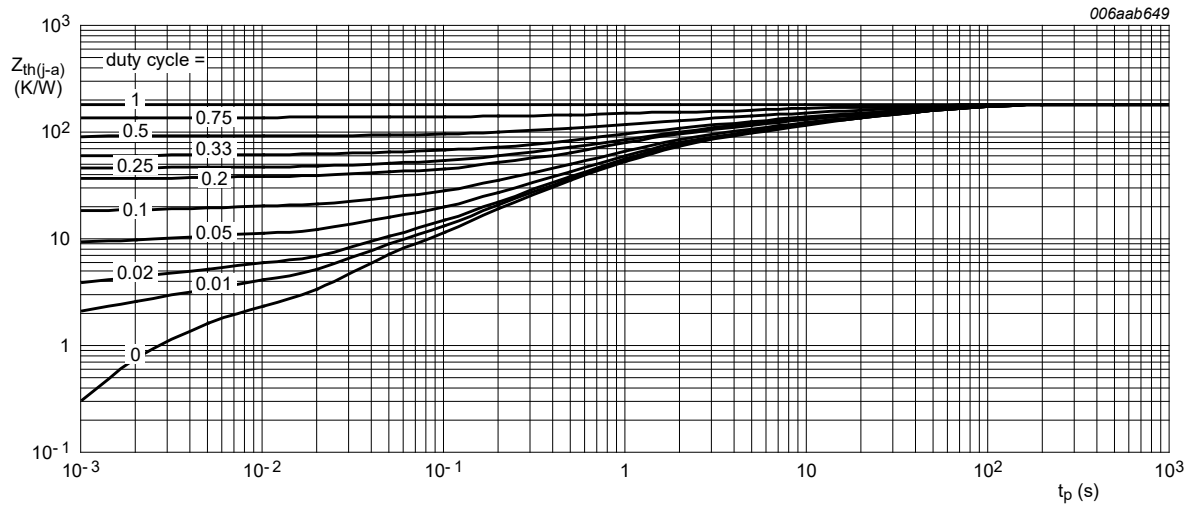
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9. Thermal characteristics

Table 6. Thermal characteristics

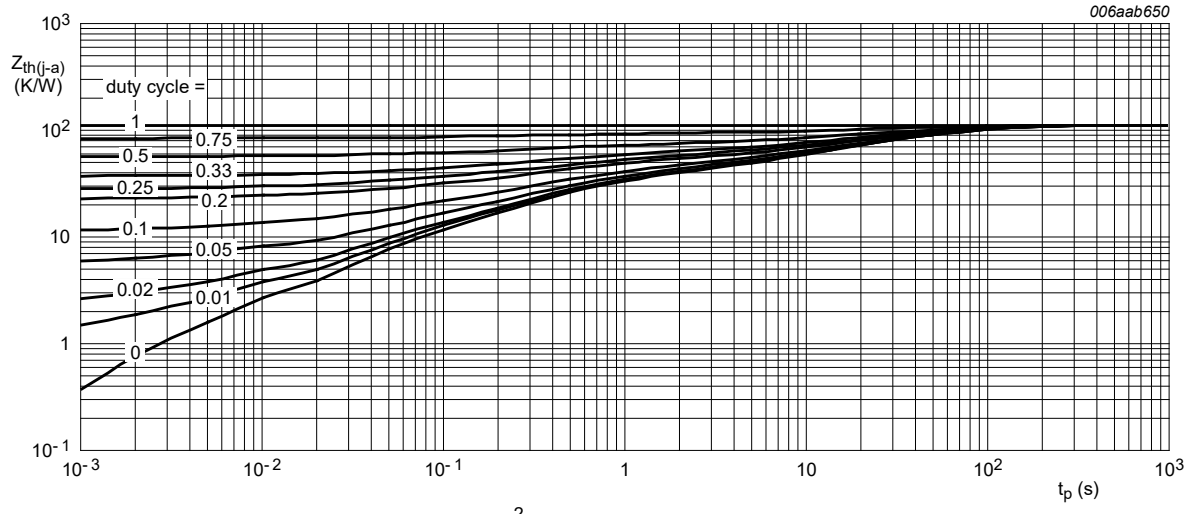
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	220	K/W
			[1] [3]	-	-	130	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	18	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2.
[4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm^2

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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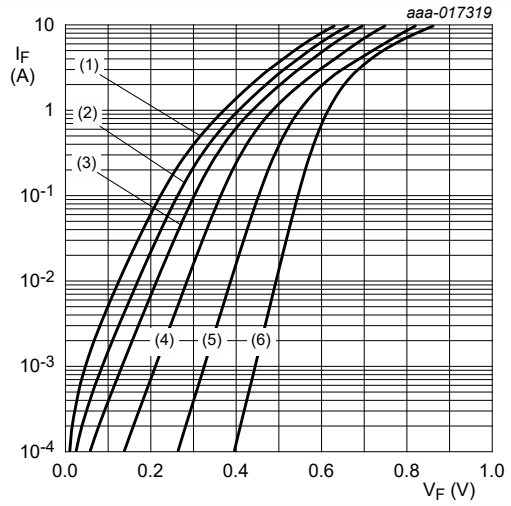
10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I_R = 1 mA; t_p = 300 µs; δ = 0.02; T_j = 25 °C		60	-	-	V
V_F	forward voltage	I_F = 0.1 A; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	450	510	mV
		I_F = 0.5 A; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	510	570	mV
		I_F = 0.7 A; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	525	590	mV
		I_F = 1 A; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	545	610	mV
		I_F = 1.6 A; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	580	650	mV
		I_F = 2 A; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	600	670	mV
		I_F = 2 A; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 125 °C		-	510	630	mV
I_R	reverse current	V_R = 10 V; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	15	-	nA
		V_R = 40 V; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	50	-	nA
		V_R = 60 V; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 25 °C		-	235	700	nA
		V_R = 60 V; t_p ≤ 300 µs; δ ≤ 0.02; T_j = 125 °C		-	285	1400	µA
C_d	diode capacitance	V_R = 1 V; f = 1 MHz; T_j = 25 °C		-	187	-	pF
		V_R = 4 V; f = 1 MHz; T_j = 25 °C		-	111	-	pF
		V_R = 10 V; f = 1 MHz; T_j = 25 °C		-	72	-	pF
t_{rr}	reverse recovery time	I_F = 0.5 A; I_R = 0.5 A; $I_{R(meas)}$ = 0.1 A; T_j = 25 °C		-	9	-	ns
V_{FRM}	peak forward recovery voltage	I_F = 0.5 A; dI_F/dt = 20 A/µs; T_j = 25 °C		-	580	-	mV

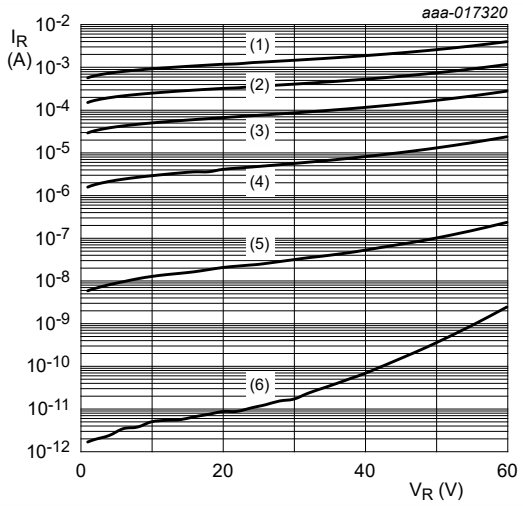
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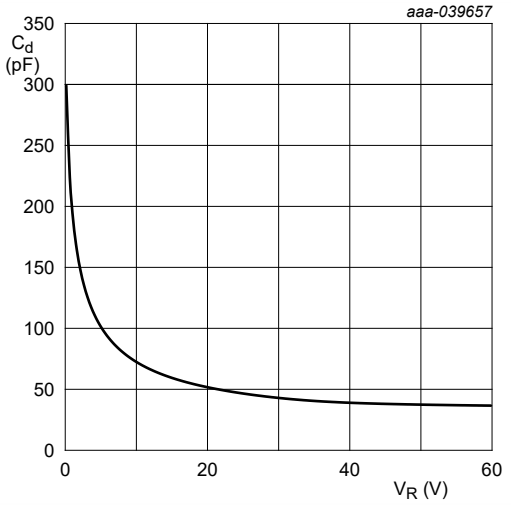
(1) T_j = 175 °C
(2) T_j = 150 °C
(3) T_j = 125 °C
(4) T_j = 85 °C
(5) T_j = 25 °C
(6) T_j = −40 °C

Fig. 3. Forward current as a function of forward voltage; typical values



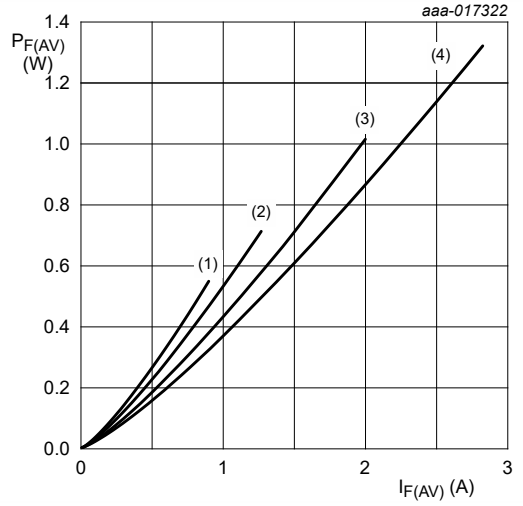
(1) T_j = 175 °C
(2) T_j = 150 °C
(3) T_j = 125 °C
(4) T_j = 85 °C
(5) T_j = 25 °C
(6) T_j = −40 °C

Fig. 4. Reverse current as a function of reverse voltage; typical values



f = 1 MHz; T_{amb} = 25 °C

Fig. 5. Diode capacitance as a function of reverse voltage; typical values

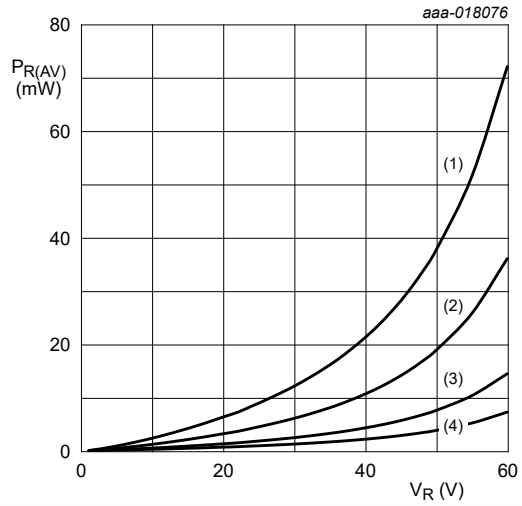


T_j = 175 °C
(1) δ = 0.1
(2) δ = 0.2
(3) δ = 0.5
(4) δ = 1

Fig. 6. Average forward power dissipation as a function of average forward current; typical values

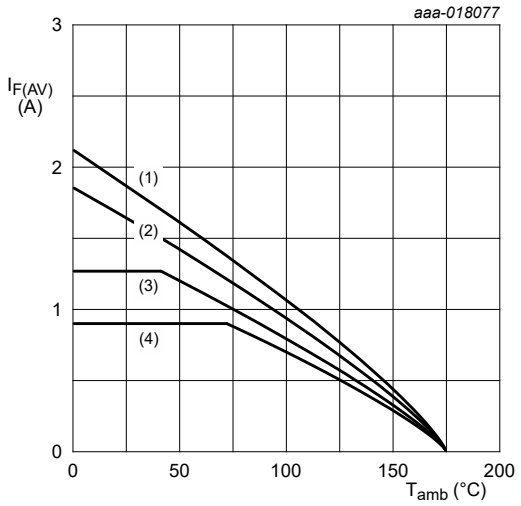
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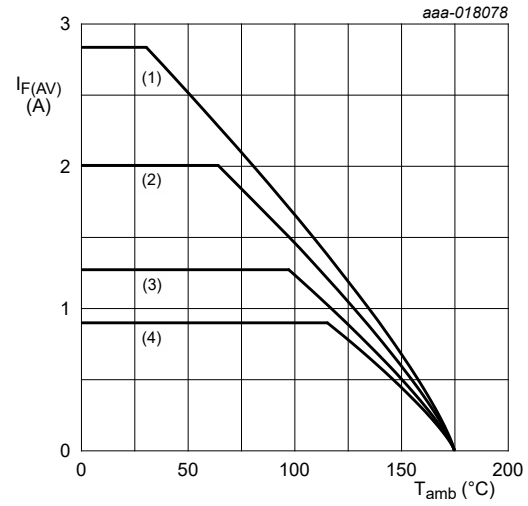
T_j = 150 °C
(1) δ = 1 (DC)
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



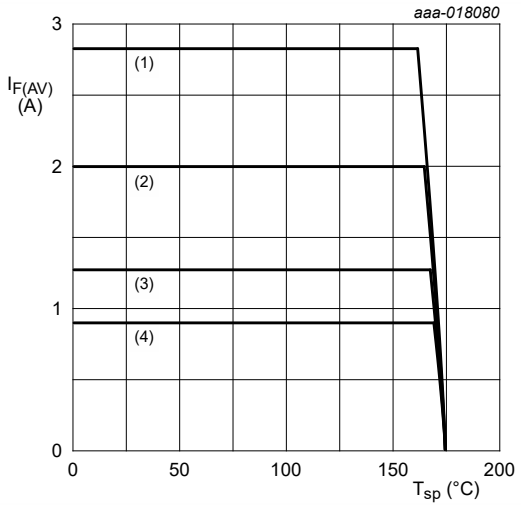
FR4 PCB, standard footprint
T_j = 175 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm^2
T_j = 175 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



T_j = 175 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

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11. Test information

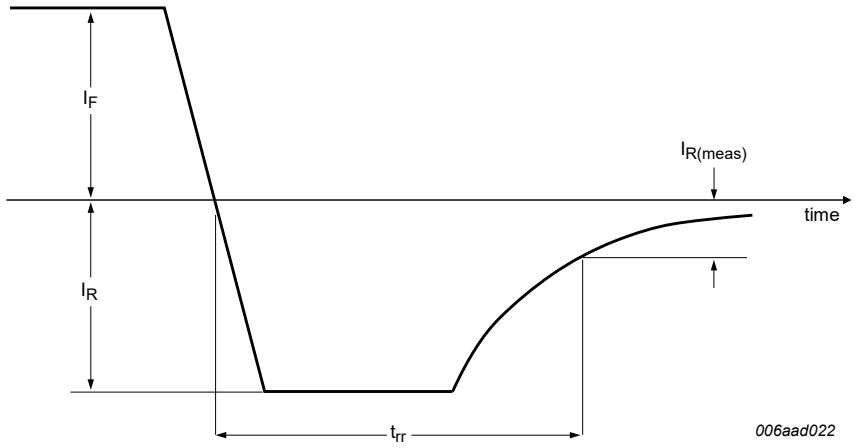


Fig. 11. Reverse recovery definition

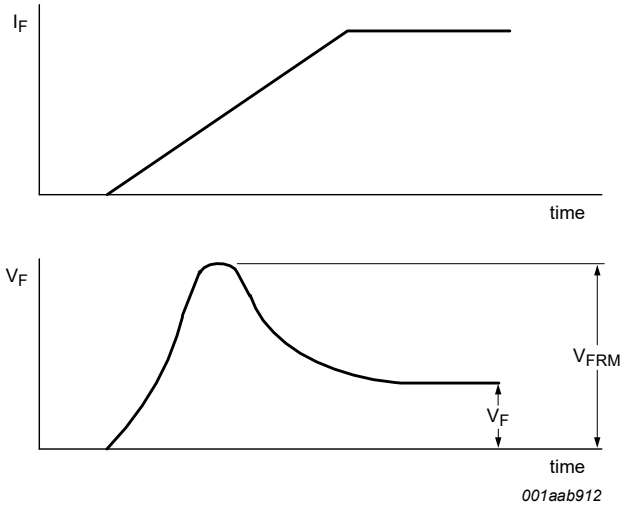


Fig. 12. Forward recovery definition

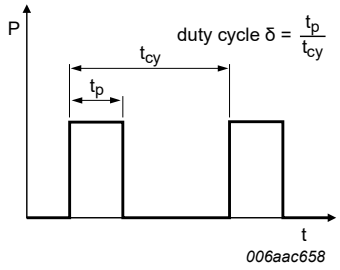


Fig. 13. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current,

$I_{RMS} = I_{F(AV)}$ at DC,

$I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

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12. Package outline

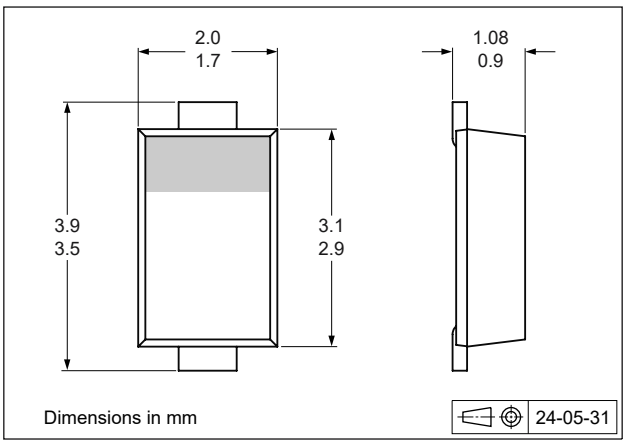


Fig. 14. Package outline SOD123FL

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13. Soldering

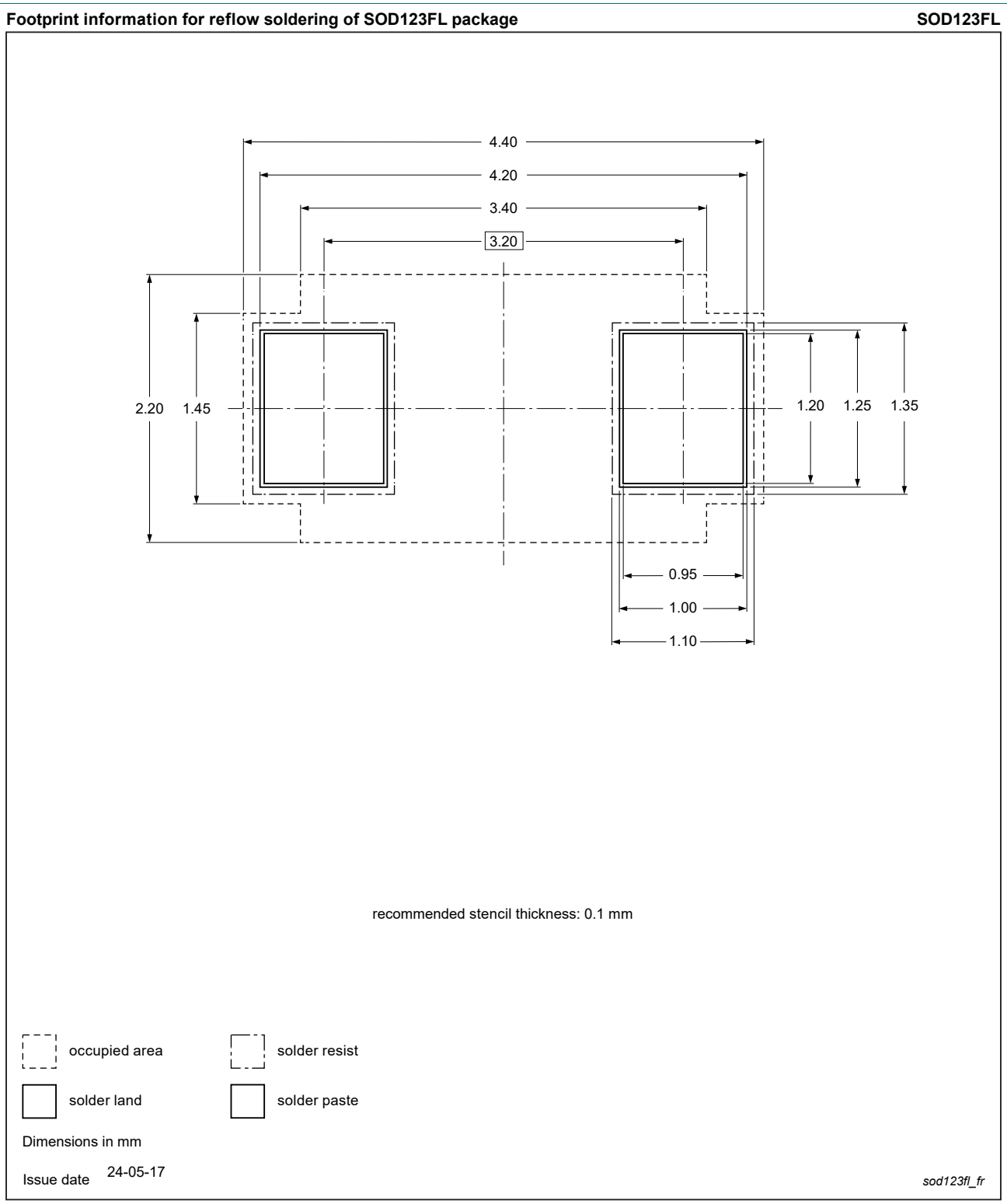


Fig. 15. Reflow soldering footprint for SOD123FL

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14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
SS26AFH v.1	20240802	Product data sheet	-	-

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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